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1.Gate 2.Drain 3.Source

70A, 650V SUPER JUNCTION MOS POWER TRANSISTOR

DESCRIPTION

SVSP65R041P7HD4 is an N-channel enhancement mode high voltage power MOSFETs produced using Silan's super junction MOS technology. It achieves low conduction loss and switching losses. It leads the design engineers to their power converters with high efficiency, high power density, and superior thermal behavior.

Furthermore, it's universal applicable, i.e., suitable for hard and soft switching topologies.

FEATURES

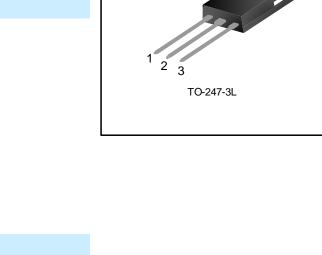
- 70A, 650V, R_{DS(on)(typ.)}=35mΩ@V_{GS}=10V
- New revolutionary high voltage technology
- Ultra low gate charge
- Periodic avalanche rated
- Extreme dv/dt rated
- High peak current capability
- 100% avalanche tested
- Pb-free lead plating
- RoHS compliant

KEY PERFORMANCE PARAMETERS

Characteristics	Ratings	Unit
V _{DS}	650	V
V _{GS(th)}	3.0~5.0	V
R _{DS(on),max} .	41	mΩ
I _{D.pulse}	210	А
Q _{g.typ.}	161	nC

ORDERING INFORMATION

Part No.	Package	Marking	Hazardous Substance Control	Packing Type
SVSP65R041P7HD4	TO-247-3L	P65R041P7	Halogen free	Tube





ABSOLUTE MAXIMUM RATINGS (UNLESS OTHERWISE NOTED, TJ=25°C)

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Characteristics	Symbol Test conditions	Min.	Тур.	Max.	Unit	
Drain-source Voltage	V _{DS}				650	V
Gate-source Voltage (Static)	V_{GS}		-20		20	V
Gate-source Voltage (Dynamic)	V _{GS}	AC(f>1 Hz)	-30		30	V
Drain Current	1	T _C =25°C			70	А
Drain Current	ID	T _C =100°C			44	А
Drain Current Pulsed (Note 1)	I _{DM}	T _C =25°C			210	А
Power Dissipation (Note 2)	PD	T _C =25°C			500	W
Single Pulsed Avalanche Energy	E _{AS}	L=79mH, V_{DD} =100V, R_G =25 Ω ,			3228	mJ
		starting temperature TJ=25°C				IIIJ
Single Pulsed Current	I _{AS}				8.4	А
Reverse Diode dv/dt	dv/dt	$V_{DS}=0~400V, I_{SD} \le I_S, T_J=25^{\circ}C$			50	V/ns
MOSFET dv/dt Ruggedness	dv/dt	V _{DS} =0~400V			50	V/ns
Operation Junction	TJ		-55		150	°C
Temperature Range	IJ		-55		150	-C
Storage Temperature Range	T _{stg}		-55		150	°C
Continuous Diode	l-				70	٨
Forward Current	ls	T _c =25°C, integral reverse P-N			70	A
Diode Pulse Current	I _S ,pulse	junction diode in the MOSFET			210	А
Maximum Diode	di/dt	V _{DS} =0~400V, I _{SD} <= I _S , T _J =25°C			900	A /u.o
Commutation Speed	ui/ui	$v_{DS}=0~400v, i_{SD}<=i_{S}, i_{J}=25°C$			900	A/µs

THERMAL CHARACTERISTICS

Characteristics	Symbol Test conditions	Ratings			Unit	
		Test conditions	Min.	Тур.	Max.	Unit
Thermal Resistance, Junction-case, Bottom	R _{ejc}			-	0.25	°C/W
Thermal Resistance, Junction-ambient	$R_{\theta J A}$	-		-	50	°C/W
Soldering Temperature (in line)	Tsold	15 ⁺² sec, 1time			260	°C



ELECTRICAL CHARACTERISTICS (UNLESS OTHERWISE NOTED, TJ=25°C)

Static characteristics

Characteristics	Symbol	Symbol Test conditions –		Ratings		
Onaracteristics	Symbol			Тур.	Max.	Unit
Drain-source Breakdown Voltage	BV_{DSS}	V _{GS} =0V, I _D =250µA	650			V
Drain aguras Laskaga Current		V _{DS} =650V, V _{GS} =0V, T _J =25°C			1.0	
Drain-source Leakage Current	I _{DSS}	V _{DS} =650V, V _{GS} =0V, T _J =125°C		18		μA
Gate-source Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V			±100	nA
Gate Threshold Voltage	V _{GS(th)}	$V_{GS}=V_{DS}$, $I_{D}=250\mu A$	3.0		5.0	V
Static Drain-source	D	V_{GS} =10V, I _D =34A, T _J =25°C		35	41	mΩ
On State Resistance	R _{DS(on)}	V _{GS} =10V, I _D =34A, T _J =150°C		77		mΩ
Gate Resistance	R_{G}	f=1MHz		1.7		Ω

Dynamic characteristics

Characteristics	Sumbol	Test conditions	Ratings			Unit
	Symbol Test conditions —	Min.	Тур.	Max.	Unit	
Input Capacitance	C _{iss}			7946		
Output Capacitance	Coss	f=1MHz, V _{GS} =0V, V _{DS} =200V		208		pF
Reverse Transfer Capacitance	C _{rss}	VDS=200V		8.0		
Turn-on Delay Time	t _{d(on)}	V 400V/V 42V/D 4.80		43		
Turn-on Rise Time	tr	$V_{DD}=400V, V_{GS}=13V, R_{G}=1.8\Omega,$		34		20
Turn-off Delay Time	t _{d(off)}	I _D =49.6A (Notos 3, 4)		98		ns
Turn-off Fall Time	t _f	(Notes 3, 4)		24		
Total Gate Charge	Qg			161		
Gate-source Charge	Q _{gs}	$V_{DD}=480V, V_{GS}=10V,$		73		nC
Gate-drain Charge	Q _{gd}	I _D =49.6A (Notes 3, 4)		60		
Gate-plateau Voltage	V _{plateau}	(Notes 3, 4)		8.2		V

Reverse diode characteristics

Characteristics	Symbol	Test conditions	Ratings			Unit
	Symbol Test conditions	Min.	Тур.	Max.	Unit	
Diode Forward Voltage	V _{SD}	I _S =50A, V _{GS} =0V			1.4	V
Reverse Recovery Time	Trr	I _S =49.6A, V _{GS} =0V, V _R =400V,		148		ns
Reverse Recovery Charge	Qrr	dI⊧/dt=100A/µs		0.79		μC
Reverse Recovery Peak Current	I _{rrm}	(Note 3)		10		А

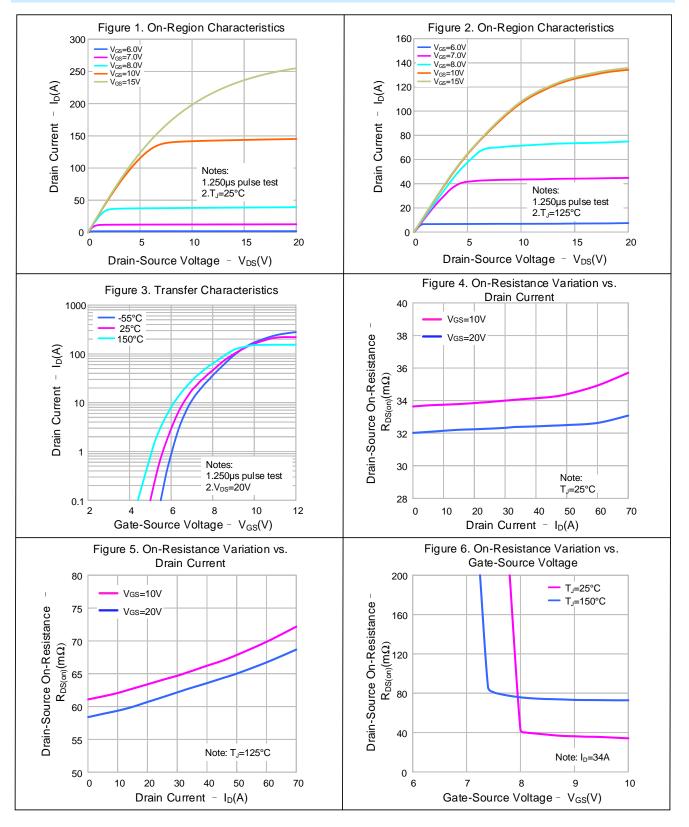
Notes:

1. Pulse time 5µs;

- 2. The dissipation power will change with temperature, derating above 25°C: 4.0W/°C;
- 3. Pulse Test: Pulse width \leq 300µs, Duty cycle \leq 2%;
- 4. Essentially independent of operating temperature.



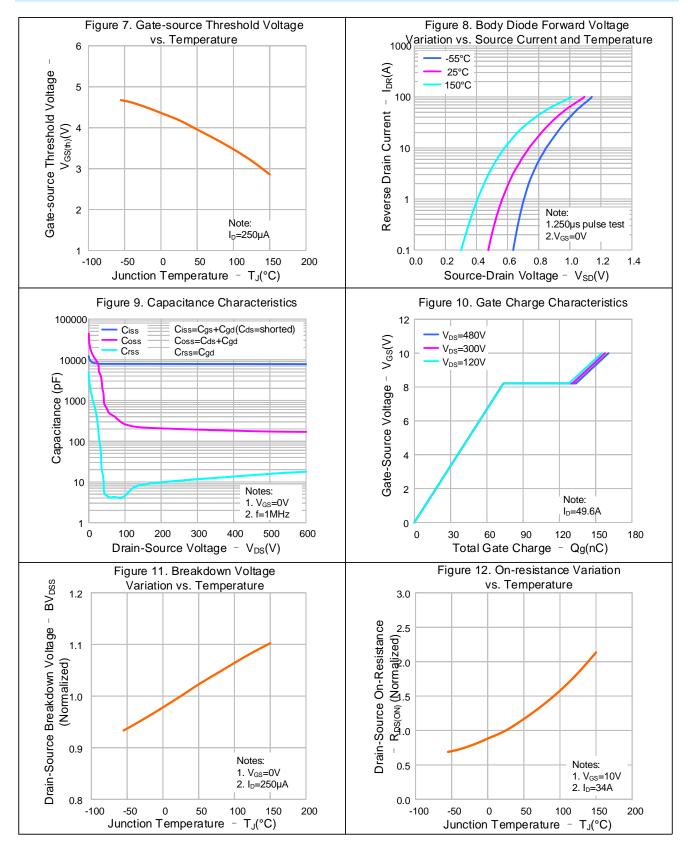
TYPICAL CHARACTERISTICS



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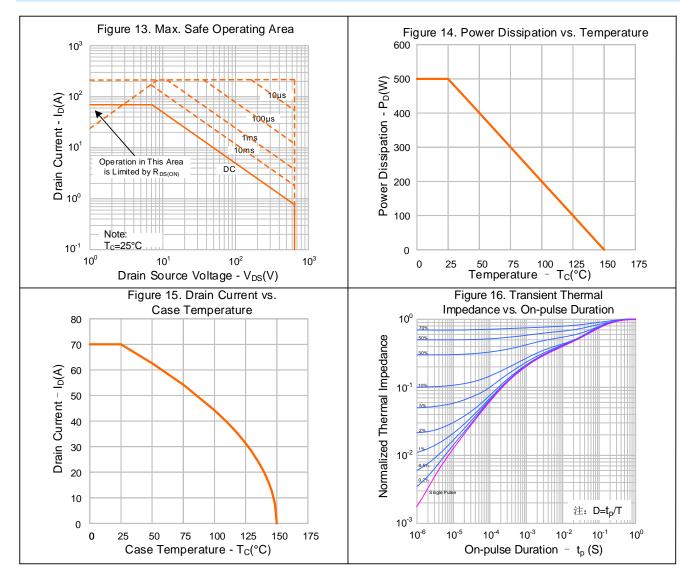
TYPICAL CHARACTERISTICS (CONTINUED)



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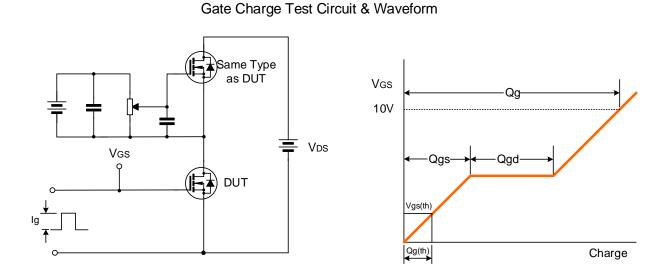


TYPICAL CHARACTERISTICS (CONTINUED)

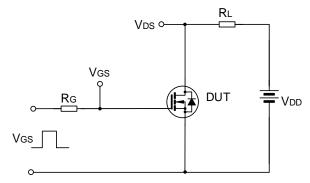


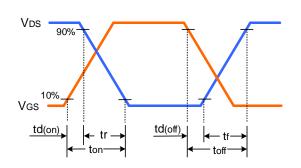


TYPICAL TEST CIRCUIT

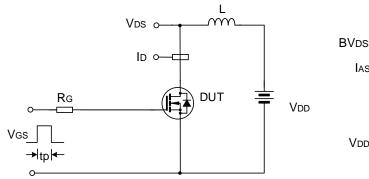


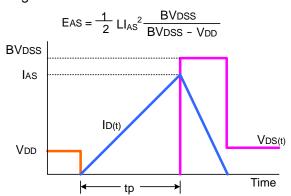
Resistive Switching Test Circuit & Waveform





Unclamped Inductive Switching Test Circuit & Waveform

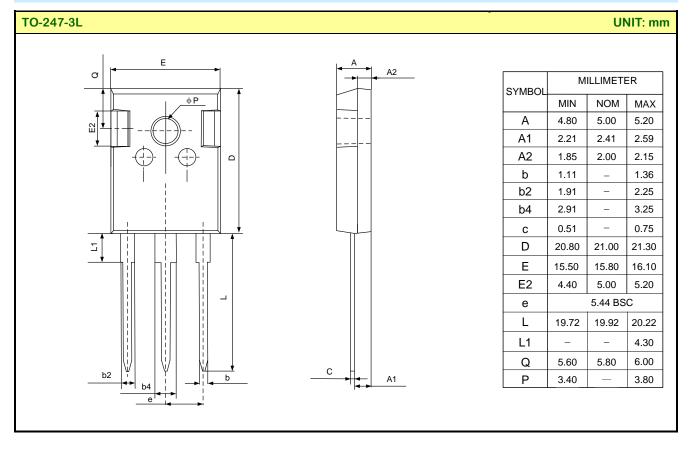




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PACKAGE OUTLINE





MOS DEVICES OPERATE NOTES:

Electrostatic charges may exist in many things. Please take following preventive measures to prevent effectively the MOS electric circuit as a result of the damage which is caused by discharge:

- The operator must put on wrist strap which should be earthed to against electrostatic.
- Equipment cases should be earthed.
- All tools used during assembly, including soldering tools and solder baths, must be earthed.
- MOS devices should be packed in antistatic/conductive containers for transportation.



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